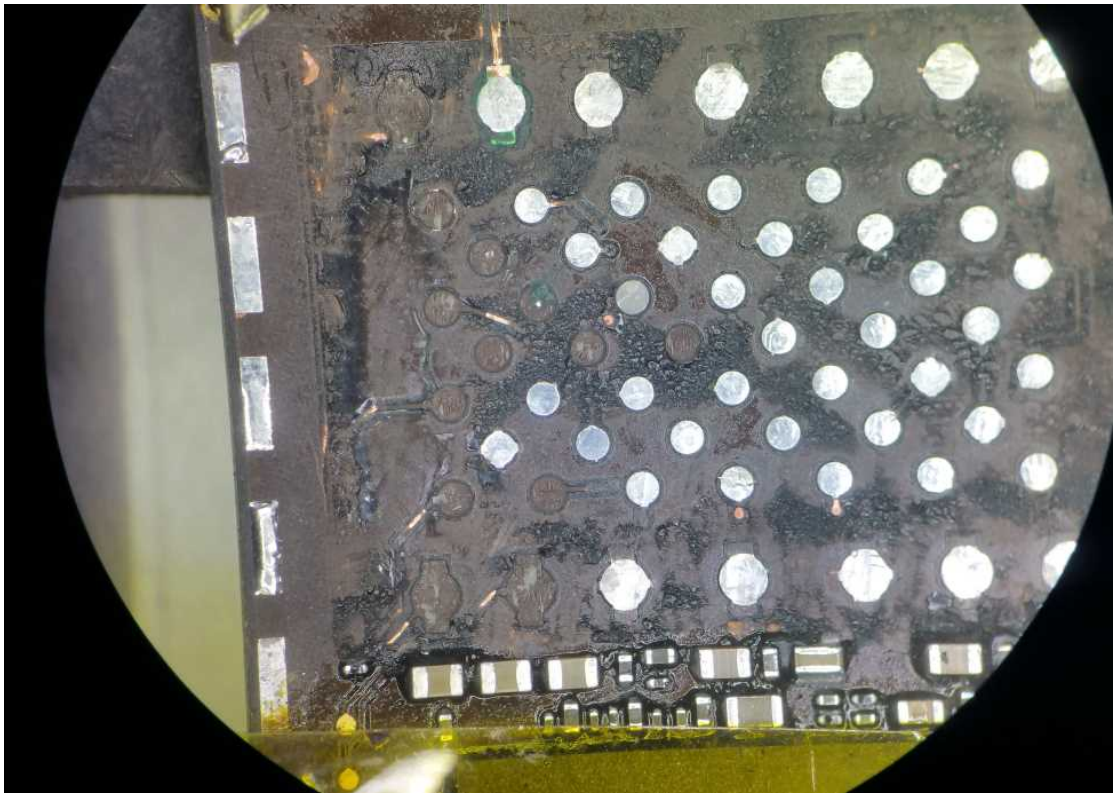
iPad AirNAND solder dot dropped repair

[Fault phenomenon]

The solution ID causes the NAND solder dot dropped.

[Maintenance process]



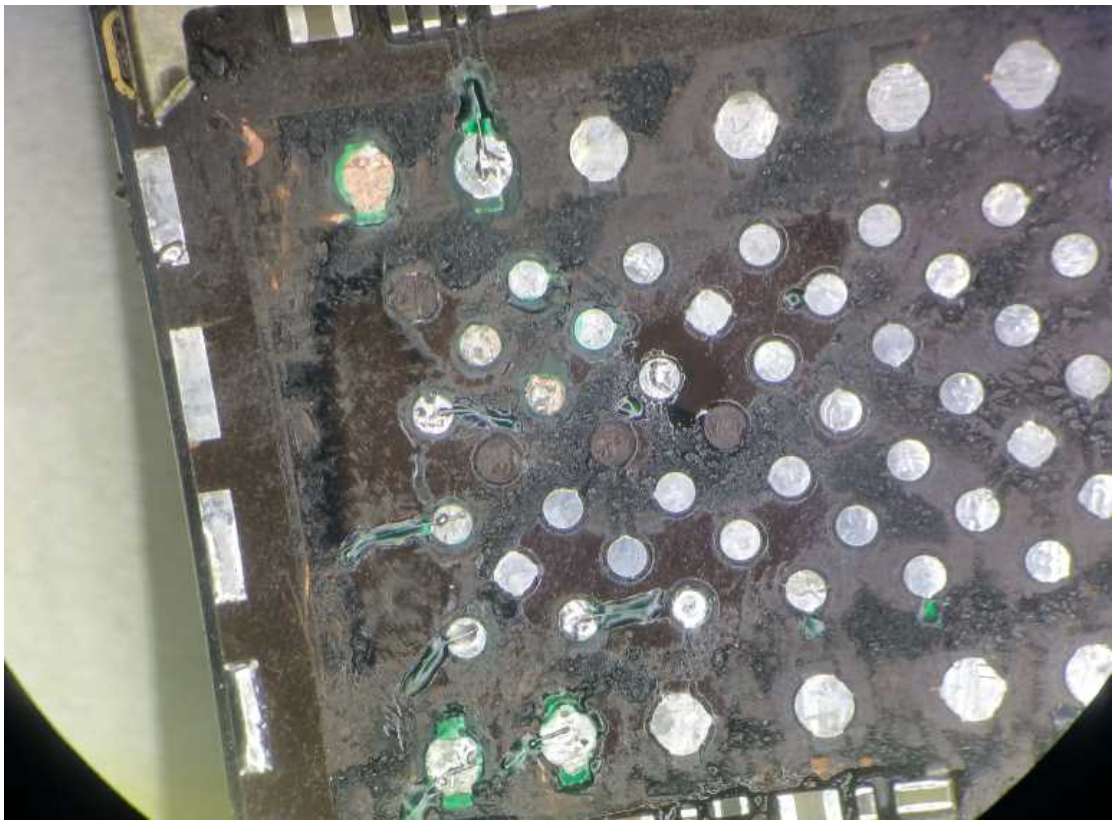
The customer hard-solved ID temperature is too low to cause the NAND solder pad solder dot dropped.There are several solder pad's intermediate layers that can't be repaired.The Add tin and weld handles the solder pad after the hole is scraped out of the middle trace.



Dig out two solder pad from the bad board and make up the motherboard of the solder dot dropped.



After the solder pad is repaired and the Test Diode Value(Multimeter uses diode gear, red pen connect GND, black measurement test point) is confirmed to be normal, the NAND is installed.



Boot test failure repair.


iPad
100%
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12月31日 星期三
己酉年冬月廿三
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